

# RZ/G3S

## AWO Example Project Start-up Guide

## Introduction

This application note describes how to set up and execute RZ/G3S AWO Example Project.

## **Target Device**

RZ/G3S

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## 1. Specifications

#### 1.1 Deliverables

#### Table 1-1. Deliverables of AWO Example Project

Deliverables	File name	Description
RZ/G3S AWO	0000-add-support-AWO-multi-os-pkg.patch	Patch for AWO support on
Patch for RZ/G	0002-enable-AWO-on-TFA.patch	RZ/G VLP
Verified Linux	• 0003-disable-TFA-AWO-M33boot-synchronous.patch	
Package (VLP)		
RZ/G3S AWO	freertos_w_awo_rzg3s_evk_ep.zip	CM33 project file for
Example Project		e2studio
RZ/G3S AWO	r01an7396ej0200_rzg3s_awo_example_project_start-	This material.
Example Project	up_guide.pdf	
Start-up Guide		

## 2. Proven Environment

#### Table 2-1. Proven Environment of AWO Example Project

Item	Contents
Integration Development Environment	e <sup>2</sup> studio 2025-07
RZ/G VLP	v3.0.7
RZ/G Flexible Software Package (FSP)	V3.1.0

## 3. AWO Example Project Setup

#### 3.1 RZ/G FSP Setup

Please refer to Getting Started with RZ/G Flexible Software Package.

## 3.2 RZ/G VLP Setup

This section described how to integrate AWO related stuff to RZ/G VLP v3.0.7.

- 1. Follow the procedure from the beginning of 2.2 Building Images to (3) Add layers of SMARC EVK of RZ/G3S Linux Start-up Guide.
- 2. Download Multi-OS Feature Package (r01an5869ej0300-rzg-multi-os-pkg.zip) to your working directory and run the commands stated below:

```
$ cd ~/rzg_vlp_<pkg ver>
$ unzip <Multi-OS download dir>/r01an5869ej0300-rzg-multi-os-pkg.zip
$ tar zxvf r01an5869ej0300-rzg-multi-os-pkg/meta-rz-features_multi-os_v3.0.0.tar.gz
```

3. Apply the patch files of Table1-1 as follows:

```
$ cd ~/rzg_vlp_<pkg_ver>
$ patch -p1 < ./r0lan5869ej0300-rzg-multi-os-pkg/0000-add-support-AWO-multi-os-pkg.patch
$ patch -p1 < ./r0lan5869ej0300-rzg-multi-os-pkg/0002-enable-AWO-on-TFA.patch
$ patch -p1 < ./r0lan5869ej0300-rzg-multi-os-pkg/0003-disable-TFA-AWO-M33boot-synchronous.patch</pre>
```

Note: 0001-bl2-cm33-coldboot-support.patch must not be applied in this AWO environment.



4. Configure the settings to start executing the CM33 program from CA55. Edit the following files with a text editor.

~/rzg\_vlp\_<pkg\_ver>/meta-renesas/meta-rzg3s/recipes-bsp/trusted-firmware-a/trusted-firmware-a.bbappend

Then add the following red part to EXTRA\_FLAGS\_smarc-RZG3S

EXTRA\_FLAGS\_smarc-rzg3s = "BOARD=smarc PLAT\_SYSTEM\_SUSPEND=awo PLAT\_M33\_BOOT\_SUPPORT=1"

5. Add the layer for Multi-OS Package

```
$ cd ~/rzg_vlp_<pkg_ver>/build
```

```
$ bitbake-layers add-layer ../meta-rz-features/meta-rz-multi-os/meta-rzg3s
```

6. Continue to set up VLP by following (4) - (5) of 2.2 Building images in SMARC EVK of RZ/G3S Linux Start-up Guide.

## 3.3 How to build AWO Example Project

Here is the procedure to build AWO Example Project:

- 1. Deploy and boot up Linux by following 3. Preparing the SD Card, 4. Reference Board Setting and 5. Booting and Running Linux of **SMARC EVK of RZ/G3S Linux Start-up Guide**.
- 2. Extract freertos\_w\_awo\_rzg3s\_evk\_ep.zip on your development PC.
- 3. Launch  $e^2$  studio and click **File** > **Import**.

	New Open File	Alt+Shift+N >
-	Recent Files	>
	Close Editor	Ctrl+W
	Close All Editors	Ctrl+Shift+W
	Save	Ctrl+S
	Save All Revert	Ctrl+Shift+S
	Move Rename	F2
8	Refresh Convert Line Delimiters To	F5
	Print	Ctrl+P
	Import	
4	Export	
	Properties	Alt+Enter
	Switch Workspace Restart Exit	>

Figure 3.1 Import of CM33 AWO Example Project (1)



4. Select Existing Projects into Workspace and click Next >.

(?) < Back Next>	Select an import wizard: Select an import wizard: Select an import wizard: Select an import wizard: Select an import situation (CS-5) project conversion to Projects from Folder or Archive Renease (Renease (CS-1) TU\$70+ Renease Web\$74+L0\$771+TU\$727+ Renease CAT8KOR (CS-1) TU\$72+ Renease CAT8KOR (CS-1	Create new projects from an archive file or directory.	Select	Import
Emith Cancel	o GCC ARM Embedded orkspace 1271- 1/271-		V	– 🗆 ×

Figure 3.2 Import of CM33 AWO Example Project (2)

5. Input the path to the directory where **freertos\_w\_awo\_rzg3s\_evk\_ep** project was extracted and click **<u>F</u>inish**.

🗿 Import	
Import Projects Select a directory to search for existing Eclipse projects.	
Select root directory:     C:\Renesas\Workspace\freertos_rzg3s_evk_e      Select archive file:	Browse Browse
Projects:	
✓ freertos_rzg3s_evk_ep_with_awo_cleanup (C:\Renesas\Workspace\f	Select All
	Deselect All
	Refresh
Options Search for nested projects Copy projects into workspace Close newly imported projects upon completion Hide projects that already exist in the workspace	
Working sets	
Add project to working sets	Ne <u>w</u>
Wgrking sets:	Sglect
? ≤ Back Next > Einish	Cancel

Figure 3.3 Import of CM33 AWO Example Project (3)



6. Build freertos\_w\_awo\_rzg3s\_evk\_ep project from Project > Build All or Build Project.



Figure 3.4 Build CM33 AWO Example Project

7. If the build is successfully completed, you can see the build artifact in **Debug** or **Release** directory as stated below:

	rzg	2024/05/13 14:53
	rzg_gen	2024/05/13 15:02
	src	2024/05/13 15:02
	freertos_rzg3s_evk_ep.elf	2024/05/13 15:02
	freertos_rzg3s_evk_ep.elf.in	2024/05/13 15:02
1	freertos_rzg3s_evk_ep.map	2024/05/13 15:02
[	freertos_rzg3s_evk_ep_rpd	2024/05/13 15:02
1	freertos_rzg3s_evk_ep.sbd	2024/05/13 15:02
	freertos_rzg3s_evk_ep.srec	2024/05/13 15:02
	freertos_rzg3s_evk_ep_cm33boot.srec	2024/05/13 15:02
	freertos_rzg3s_evk_ep_non_secure_code.bin	2024/05/13 15:02
1	freertos_rzg3s_evk_ep_non_secure_vector.bin	2024/05/13 15:02
1	freertos_rzg3s_evk_ep_secure_code.bin	2024/05/13 15:02
Ĩ	freertos_rzg3s_evk_ep_secure_vector.bin	2024/05/13 15:02
1	makefile	2024/05/13 15:02
1	makefile.init	2024/05/13 15:02
1	memory_regions.ld	2024/05/13 14:53
[	objects.mk	2024/05/13 15:02
	sources.mk	2024/05/13 15:02

Figure 3.5 Build Artifact of CM33 AWO Example Project



#### 3.4 How to deploy AWO Example Project

This section describes how to deploy the AWO example program built in the previous chapter to the board. To write to the SPI flash on the board, use the Flash Writer in the RZ/G VLP Linux package.

## 3.4.1 For QSPI boot (1.8V)

- 1. Follow the procedure from the beginning of 4 Reference Board Setting to 4.4 Write the Bootloader of RZ/G3S Linux Start-up Guide.
- 2. Program freertos\_w\_rzg3s\_evk\_ep.srec with Flash Writer as shown below:

```
> xls2
===== Qspi writing of RZ/G2 Board Command ============
Load Program to Spiflash
Writes to any of SPI address.
Program size & Qspi Save Address
===== Please Input Program Top Address =========
 Please Input : H'80200000
===== Please Input Qspi Save Address ===
 Please Input : H'200000
please send ! ('.' & CR stop load)
Erase SPI Flash memory...
Erase Completed
Write to SPI Flash memory.
SpiFlashMemory Stat Address : H'00200000
SpiFlashMemory End Address : H'0020D16E
_____
```

3. Continue to set up board by following **4.5 Change Back to Normal Boot Mode** in **SMARC EVK of RZ/G3S Linux Start-up Guide**.



## 3.4.2 For eMMC boot (1.8V)

- 1. Follow the procedure from the beginning of 8.2 How to boot from eMMC to Send the data of "fipsmarc-rzg3s.srec" in 8.2.1 Writing Bootloader for eMMC Boot.
- 2. Program freertos\_w\_rzg3s\_evk\_ep.srec with Flash Writer as shown below:

```
> EM_W
EM_W Start -----
_____
Please select, eMMC Partition Area.
0:User Partition Area : 62160896 Kbytes
 eMMC Sector Cnt : H'0 - H'0768FFFF
1:Boot Partition 1 : 32256 Kbytes
 eMMC Sector Cnt : H'0 - H'0000FBFF
2:Boot Partition 2 : 32256 Kbytes
 eMMC Sector Cnt : H'0 - H'0000FBFF
Select area(0-2)>1
-- Boot Partition 1 Program -----
Please Input Start Address in sector :1000
Please Input Program Start Address : 80200000
Work RAM (H'00020000-H'000FFFFF) Clear....
please send ! ('.' & CR stop load)
```

3. Continue to set up board by following 8.2.1 Writing Bootloader for eMMC Boot.



## 4. AWO Example Program Invocation

This chapter describes how AWO Example Program works.

- 1. Boot up Linux kernel.
- 2. Login as root.

```
smarc-rzg3s login: root
```

3. Invoke the commands below on Linux console to move Linux to Suspend to RAM (S2R):

```
root@smarc-rzg3s:~# echo deep > /sys/power/mem_sleep
root@smarc-rzg3s:~# echo mem > /sys/power/state
```

4. When Linux successfully moves to S2R, you should see the following display on Linux console:

```
[ 1082.105386] PM: suspend entry (deep)
[ 1082.109183] Filesystems sync: 0.000 seconds
[ 1082.122622] Freezing user space processes ... (elapsed 0.001 seconds) done.
[ 1082.131266] OOM killer disabled.
[ 1082.134496] Freezing remaining freezable tasks ... (elapsed 0.001 seconds) done.
[ 1082.143134] printk: Suspending console(s) (use no_console_suspendto debug)
CM33:Init PMIC for AWO mode
CM33:AWO Mode
```

Hit any key to go to ALLON mode.

RZ/G3S now moves to AWO, and only CM33 AWO Example Project can work. (Note)

Note: On Linux console, Line Feed (LF) should be specified as New Line Code.



5. When typing any key on Linux Console, RZ/G3S starts to move to ALLON, and Linux should be resumed as shown below:

```
Hit any key to go to ALLON mode.
CM33:Set GreenPAKto ALLON
NOTICE: BL2: v2.7(release):2.7.0/g3s_1.0.0_rc4
NOTICE: BL2: Built : 11:52:53, Feb 292024
NOTICE: BL2: Booting BL31
[ 60.710450] ehci-platform 11e30100.usb: port 1 resume error -110
[ 60.836140] usbusb2-port1: device 2-1 not suspended yet
[ 60.880506] Disabling non-boot CPUs ...
[ 60.899495] Microchip KSZ9131 Gigabit PHY 11c30000.ethernet-ffffffff:07: attached PHY driver
[Microchip KSZ9131 Gigabit PHY] (mii_bus:phy_addr=11c30000.ethernet-ffffffff:07, irq=137)
[ 60.920867] Microchip KSZ9131 Gigabit PHY 11c40000.ethernet-ffffffff:07: attached PHY driver
[Microchip KSZ9131 Gigabit PHY] (mii_bus:phy_addr=11c40000.ethernet-ffffffff:07, irq=138)
[ 61.017924] usbusb3: root hub lost power or was reset
[ 61.018018] usbusbl: root hub lost power or was reset
[ 61.105918] usbusb4: root hub lost power or was reset
[ 61.106020] usbusb2: root hub lost power or was reset
[ 61.309991] OOM killer enabled.
[ 61.313131] Restarting tasks ...
[ 61.313647] usb2-1: USB disconnect, device number 2
[ 61.334271] done.
[ 61.352163] PM: suspend exit
[ 61.619922] usb2-1: new high-speed USB device number 3 using ehci-platform
[ 61.788714] hub 2-1:1.0: USB hub found
[ 61.798400] hub 2-1:1.0: 4 ports detected
root@smarc-rzg3s:~#
```



## 5. Sequence Diagram of AWO Example Project

## 5.1 Brief Sequence of AWO Example Project



Figure 1. Brief Sequence of AWO Example Project



## 5.2 Suspend Sequence of TF-A



Figure 2. TF-A Suspend Sequence



## 5.3 Resume Sequence of TF-A



Figure 3. TF-A Suspend Sequence



## 6. Assignment of peripherals for AWO mode

On RZ/G3S, only the peripherals which belong to PD\_VCC domain can continue to work under AWO mode. For details, please refer to 41. Low Power Consumption in RZ/G3S Group User's Manual. Table 5.1 shows the expected assignment of peripherals to CA55 and CM33 on this example project.

Table 5.1 Peri	pherals assi	anment on	AWO Exa	mple Pro	iect
	pricials assi	ginnent on			,

Peripherals	CPU		Remarks
	CA55	CM33	
ADC	Х		
CANFD		Х	
DMA (Non Secure)	Х		
DMA (Secure)		Х	
GPT	Х		
I2C	Х		
I3C	Х		
MTU3	Х		
POE	Х		
POEG	Х		
SCI	Х		
SCIF	ch0, ch2-5	ch1	Assumed use case of SCIF ch1 on CM33 is to get
			Pmod USBUART to be worked for the console dedicated to CM33.
SPDIF	Х		
RSPI	ch1-4	ch0	Assumed use case of RSPI ch0 on CM33 is to get
			Pmod SF3 to be worked on RZ/G3S Smarc EVK.
SSI	X		
TSU	Х		
WDT	ch0	ch1, ch2	
GTM	ch4-7	ch0-3	
xSPI	X		



## 7. Function Reference of AWO Example Project

## 7.1.1 awo\_task\_entry

```
void awo_task_entry (void *pvParameters)
```

#### • Parameters

- pvParameters Pointer to the parameter passed to AWO task.
- Returns

None

#### • Description

This function is the entry function of AWO task.

Here is the overview of processing flow:

- 1. Set up timer.
- 2. Wait until Arm® Cortex®-A55 (hereinafter referred to as CA55) Linux enters Suspend-to-RAM.
- 3. Configure RZ/G3S and PMIC as AWO.
- 4. Wait until key input to console is issued.
- 5. Configure RZ/G3S and PMIC as ALLON.
- 6. Return to 2.

#### 7.1.2 backup\_sram

#### • Parameters

- sys\_ca55\_cfg\_rval\_back
   Pointer to the buffer where lower 32-bit of reset vector base address is stored.
- sys\_ca55\_cfg\_rvah\_back
   Pointer to the buffer where upper 32-bit of reset vector base address is stored.
- Returns

None

• Description

This function first copies the contents in SRAM ACPU0 to the dedicated area in SRAM MPU1. Then, CA55 reset vector address should be copied to the buffer specified by the parameters. The reset vector base address will be restored when transiting from AWO to ALLON mode for the resume of CA55 Linux.



## 7.1.3 set\_pmic

static void set\_pmic(void)

#### • Parameters

None

# Returns None

#### • Description

Configure Power Management IC (PMIC) RAA215300A2GNP#HA3 mounted on RZ/G3S SMARC EVK specific to AWO mode.

#### 7.1.4 wait\_ca55\_sleep

static void wait\_ca55\_sleep(void)

## • Parameters

None

Returns

None

#### • Description

Issue the request to CA55 Linux to transit to sleep state and wait until the transition is completed.

#### 7.1.5 q\_channel\_stop

```
static void q_channel_stop(void)
```

• Parameters

None

Returns

None

#### • Description

Stop clock supply to peripheral clock domain and bus bridge via Q-Channel.



## 7.1.6 stop\_ca55\_clock

static void stop\_ca55\_clock(void)

- Parameters
   None
- Returns
  - None
- Description

Stop the clock supply to CA55.

## 7.1.7 assert\_ca55\_reset

static void assert\_ca55\_reset(void)

- Parameters None
- Returns None
- **Description** Carry out reset assertion of CA55.



#### 7.1.8 stop\_module

```
static void stop_module(void)
```

```
• Parameters
```

None

Returns

None

## • Description

Transit all the modules assigned to the registers listed below to Module Stop State:

- MSTOP Register ACPU (CPG\_BUS\_ACPU\_MSTOP)
- MSTOP Register PERI\_COM (CPG\_BUS\_PERI\_COM\_MSTOP)
- MSTOP Register PERI\_DDR (CPG\_BUS\_PERI\_DDR\_MSTOP)
- MSTOP Register TZCDDR (CPG\_BUS\_TZCDDR\_MSTOP)
- MSTOP Register MHU (CPG\_MHU\_MSTOP)
- Power Down MSTOP Register (CPG\_PWRDN\_MSTOP)



#### 7.1.9 stop\_clock\_assert\_reset

static void stop\_clock\_assert\_reset(void)

#### • Parameters

None

#### • Returns

None

#### • Description

Stop the clock supply assigned to the registers listed below:

- Clock Control Register AXI\_ACPU\_BUS (CPG\_CLKON\_AXI\_ACPU\_BUS)
- Clock Control Register AXI\_COM\_BUS (CPG\_CLKON\_AXI\_COM\_BUS)
- Clock Control Register PERI\_COM (CPG\_CLKON\_PERI\_COM)
- Clock Control Register PERI\_DDR (CPG\_CLKON\_PERI\_DDR)
- Clock Control Register AXI\_TZCDDR (CPG\_CLKON\_AXI\_TZCDDR)
- Clock Control Register Cortex-M33 (hereinafter referred to as CM33) (CPG\_CLKON\_CM33)
- Power Down IP Register 1 (CPG\_PWRDN\_IP1)
- Power Down IP Register 2 (CPG\_PWRDN\_IP2)

Configure the unit clock associated with the register below as Power Down mode:

• Power Down CLKON Register (CPG\_PWRDN\_CLKON)

Cofigure the reset pin associated with the register below as Power Down mode:

• Power Down RST Register (CPG\_PWRDN\_RST)

Assert the reset signal associated with the registers listed below:

- Reset Control Register AXI\_ACPU\_BUS (CPG\_RST\_AXI\_ACPU\_BUS)
- Reset Control Register AXI\_COM\_BUS (CPG\_RST\_AXI\_COM\_BUS)
- Reset Control Register PERI\_COM (CPG\_RST\_PERI\_COM)
- Reset Control Register AXI\_TZCDDR (CPG\_RST\_AXI\_TZCDDR)

Turn off the USB Region Power by configuring USB PWRRDY Register (SYS\_USB\_PWRRDY). Assert PCI\_ARESETN reset signal with SYS\_PCIE\_RST\_RSM\_B and wait until it's actually asserted by monitoring Reset Monitor Register PCI (CPG\_RSTMON\_PCI register.

#### 7.1.10 sleep\_enable\_on\_greenpack

static void sleep\_enable\_on\_greenpack(void)

Parameters
 None

none

Returns
 None

#### • Description

Configure Sleep Enable of GreePAK (SLG7RN46131) connected with RIIC ch1 as ON.



#### 7.1.11 sleep\_enable\_off\_greenpack

static void sleep\_enable\_off\_greenpack(void)

- Parameters
   None
- Returns None
- **Description** Configure Sleep Enable of GreePAK (SLG7RN46131) connected with RIIC ch1 as OFF.

#### 7.1.12 wait\_pd\_isovcc\_stable

static void wait\_pd\_isovcc\_stable(void)

- Parameters None
- Returns

None

• Description

Wait for the power supply for PD\_ISOVCC from PMIC. In the current sample program, 5 msec wait is inserted as an example. Then, DDR is turned on.

#### 7.1.13 pd\_isovcc\_power\_supply

static void pd\_isovcc\_power\_supply(void)

- Parameters
   None
- Returns
   None
- **Description** Disable the isolation cell for PD\_ISOVCC.



#### 7.1.14 restore\_sram\_repair\_information

static void restore\_sram\_repair\_information(void)

• Parameters

None

- Returns
   None
- **Description** Restore SRAM repair information.

#### 7.1.15 negate\_ip\_power\_down

static void negate\_ip\_power\_down(void)

- Parameters None
- Returns
   None
- **Description** Negate Power Down mode of IPs assigned to PD\_ISOVCC region.

#### 7.1.16 start\_system\_bus\_clock

static void start\_system\_bus\_clock(void)

- Parameters
   None
- Returns

None

Description
 Start the clock supply to System Bus and Peripherals assigned to PD\_ISOVCC region.



#### 7.1.17 negate\_system\_bus\_reset

static void negate\_system\_bus\_reset(void)

• Parameters

None

- Returns
   None
- Description Negate reset signal of System Bus and Peripherals assigned to PD\_ISOVCC region.

#### 7.1.18 start\_module

static void start\_module(void)

- Parameters
   None
- Returns
   None
- Description

Transmit Peripherals assigned to PD\_ISOVCC from Module Stop State to Normal Operation state.

#### 7.1.19 restore\_sram

static void restore\_sram(volatile uint32\_t \*dummy\_read)

- Parameters
  - dummy\_read

Pointer to the buffer where SRAM ACPU0 data to be backed up by backup\_sram function is stored.

• Returns

None

• Description

Restore SRAM ACPU0 data that was backed up by backup\_sram function. Be sure to call this function after backup\_sram is invoked. Otherwise, the data copied to SRAM\_ACPU0 should be unpredictable.



## 7.1.20 negate\_ca55\_reset

- Parameters
  - sys\_ca55\_cfg\_rval\_back

Lower 32-bit of reset vector address to be backed up by backup\_sram function.

- sys\_ca55\_cfg\_rval\_back
   Upper 32-bit of reset vector address to be backed up by backup\_sram function.
- Returns

None

#### • Description

Start the clock supply to CA55 and then carry out the reset release of CA55.



## 8. Appendix

## 8.1 Debugging CM33 AWO Example Project from e2studio

This chapter describes how to debug an AWO example project from e2studio.

If you want to debug from e2studio, you need to rebuild TF-A. Follow the steps below to recreate the TF-A.

1. Build RZ/G VLP with skipping Step 4 of "**3.2 RZ/G VLP Setup**" In other words, **trusted-firmware-a.bbappend** will be built in the following state:

```
EXTRA_FLAGS_smarc-rzg3s = "BOARD=smarc PLAT_SYSTEM_SUSPEND=awo"
```

2. Write the rebuilt TF-A to the board according to 3.4 How to deploy AWO Example Project.

Once you have completed the above preparations, open the AWO project in e2studio and start debugging by following the steps:

1. Configure the debugger for freertos\_w\_awo\_rzg3s\_evk\_ep project from <u>Run > Debug</u> Configurations....



Figure 8.1 Debug Configuration of CM33 AWO Example Project (1)



2. Extract Renesas DGB Hardware Debugging, choose freertos\_w\_awo\_rzg3s\_evk\_ep.elf and click Debug.

Create, manage, and run configurations			Ŕ
1 🛙 🕫 🖿 🗶 🖨 🏹 🕶	Name: freertos_rzg3s_evk_ep_with_awo_cleanu	up.elf	
type filter text	📄 Main 🕸 Debugger 🍉 Startup 🦆 Sour	rce 🔲 Common	
C/C++ Application	Project:		
EASE Script	freertos_rzg3s_evk_ep_with_awo_cleanup		Browse
GDB Hardware Debugging	C/C++ Application:		
C GDB Simulator Debugging (RH850)	Debug/freertos_rzg3s_evk_ep_with_awo_cleanup.elf		
Renesas GDB Hardware Debugging     freertos_rzg3s_evk_ep_with_awo_cleanup.elf	Variables	Search Project	Browse
💽 Renesas Simulator Debugging (RX, RL78)	Build Configuration: Use Active		.~
	C Enable auto build     O I     O Use workspace settings     Cor	Disable auto build nfigure Workspace Set	ings
Filter matched 9 of 12 items		Reyert	Apply

Figure 8.2 Debug Configuration of CM33 AWO Example Project (2)

3. Now the load module of CM33 AWO Example Project has been loaded and Program Counter (PC) should indicate the top of Warm\_Reset\_S function. Then, click **Run** > **Run** for continuing the invocation.

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Figure 8.3 Run CM33 AWO Example Project (1)



- 4. Program should stop at the top of main function. Click Run > Run again to continue. Now, CM33 AWO Example Program should be working.
- 5. Log in to Linux as **root** user.

## 8.2 Restrictions

This AWO Example environment has the following restrictions regarding the boot mode.

- CM33 coldboot is not supported. Use this environment with CA55 coldboot.
- eSD boot is not supported.



## **Revision History**

		Description	
Rev.	Date	Page	Summary
1.00	Jul.31.24	-	1st revision issued.
1.01	Sep.30.24	3	Updated the deliverables stated in Table 1-1.
		3	Updated 3.2 RZ/G VLP Setup in accordance with the update of deliverables.
1.02	Apr.25.25	3	Updated the deliverables stated in Table 1-1.
		3-10	Added a process to apply RZ/G Multi-OS Package to the setup procedure.
		26	Added boot mode restriction.
2.00	Jul.22.25	3	Updated the deliverables stated in Table 1-1.
		3	Updated 3.2 RZ/G VLP Setup in accordance with the update of deliverables.
		7-8	Updated the address specified for the SerialFlashWriter to match the latest version.



# General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

#### 1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between  $V_{IL}$  (Max.) and  $V_{IH}$  (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a systemevaluation test for the given product.

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